

Radiation-Hardened Dual 3-Input Majority Voter with cold sparing

1 GENERAL DESCRIPTION

The AP54RHC301 is a radiation-hardened by design dual 3-Input Majority Voter that is ideally suited for space, medical imaging and other applications demanding radiation tolerance and high reliability. It is fabricated in a 180 nm CMOS process utilizing proprietary radiation-hardening techniques, delivering high resiliency to single-event effects (SEE) and to a total ionizing dose (TID) up to 30 krad (Si).

This device is a member of the Apogee Semiconductor AP54RHC logic family operating across a voltage supply range of 1.65 V to 5.5 V.

The AP54RHC301 is an unique discrete majority voter logic function that offers two instances of a triple-input voter gate, with individual error outputs. In addition, a dedicated "error detected" indication is available, in addition to an external error input signal.

Zero-power penalty™ cold sparing is supported, along with Class 2 ESD protection on all inputs and outputs. A proprietary output stage and robust power-on reset (POR) circuit allow the AP54RHC301 to be cold-spared in any redundant configuration with no static power loss on any pad of the device. The redundant output stage also features a high drive capability with low static power loss.

The AP54RHC301 also features a triple-redundant design throughout its entire circuitry, which allows it to be immune to single-event transients (SET) without requiring additional redundant devices.

Ordering information may be found in Table 9 on Page 13.

1.1 FEATURES

- · 1.65 VDC to 5.5 VDC operation
- Inputs tolerant up to 5.5 VDC at any V_{CC}
- Provides logic-level down translation to V_{CC}
- Extended operating temperature range (-55 °C to +125 °C)

- Proprietary cold sparing capability with zero static power penalty
- Built-in triple redundancy for enhanced reliability

 Internal power-on reset (POR) circuitry ensures
 reliable power up and power down responses during hot plug and cold sparing operations

- Class 2 ESD protection (4000 V HBM, 500 V CDM)
- TID resilience of 30 krad (Si)
- · SEL immune up to LET of 80 MeV-cm²/mg

1.2 LOGIC DIAGRAM

The AP54RHC301 logic function is shown below:

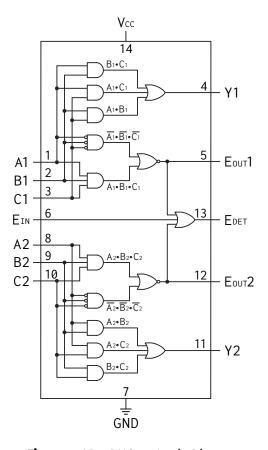


Figure 1: AP54RHC301 Logic Diagram

AP54RHC301

Rad-Hard Dual 3-Input Majority Voter with cold sparing

DATASHEET

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1	1.1	eral Description Features	1		5.5 5.6	Radiation Resilience	7 7
	1.2	Logic Diagram	1	6	Det	ailed Description	8
3		onyms and Abbreviations ic Data Truth Table	2 3 3	7	App 7.1 7.2 7.3	Applications Information Applications Example	
4	Pin	Configuration	3	8		kaging Information	11
5	Elec 5.1	ctrical Characteristics Absolute Maximum Ratings	4 4	9		lering Information	13
	5.2 5.3	Recommended Operating Conditions Static Characteristics	5	10	Rev	rision History	14
	5.4	Dynamic Characteristics	7	11	Leg	al	15
LI	1	OF TABLES Truth Table	3		6	DC Electrical Characteristics	
	2 3 4 5	Device Pinout	3 4 5 5		7 8 9 10	AC Electrical Characteristics Radiation Resilience Characteristics Ordering Information	7 13
LI	ST (OF FIGURES					
	1 2 3 4 5 6	AP54RHC301 Logic Diagram Device Pinout Load Circuit Propagation Delay Input Pin Structure Output Pin Structure	1 3 7 7 8 8		7 8 9 10 11	Voter Example	10 11 12

2 ACRONYMS AND ABBREVIATIONS

ESD	Electrostatic Discharge
POR	Power On Reset
RHA	Radiation Hardness Assurance
SEE	Single Event Effects
SEL	Single Event Latchup
SET	Single Event Transient
TID	Total Ionizing Dose
TMR	Triple Modular Redundancy
CDM	Charged-device Model
HBM	Human-body Model



3 LOGIC DATA

3.1 TRUTH TABLE

The AP54RHC301 truth table is found in Table 1. **H** indicates HIGH logic level, **L** indicates LOW logic level and **X** indicates DON'T CARE. Subscript **n** reflects one of the two functions in the device (1 to 2).

Table 1: AP54RHC301 Device Truth Table

	Input			utput
An	B _n	Cn	Yn	E _{OUT} n
L	L	L	L	L
L	L	Н	L	Н
L	Н	L	L	Н
L	Н	Н	Н	Н
Н	L	L	L	Н
Н	L	Н	Н	Н
Н	Н	L	Н	Н
Н	Н	Н	Н	L

Input	Intern	Output	
E _{IN}	E _{OUT} 1 E _{OUT} 2		E _{DET}
L	L	L	L
Х	Х	Н	Н
X	Н	Х	Н
Н	Х	Х	Н

4 PIN CONFIGURATION

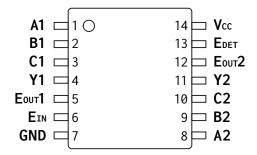


Figure 2: AP54RHC301 Device Pinout

Table 2: AP54RHC301 Device Pinout

PIN NAME(S)	PIN NUMBER(S)	DESCRIPTION	
A1, B1, C1	1, 2, 3	Logic Inputs	
A2, B2, C2	8, 9, 10	Logic inputs	
Y1	4	Logic Outputs	
Y2	11	Logic Outputs	
E _{IN}	6	External Voter Error Input	
E _{OUT} 1	5	Internal Voter Error Outputs	
E _{OUT} 2	12	internat voter Error Outputs	
E _{DET}	13	Error Detected Output	
V _{CC}	14	Positive Voltage Supply	
GND	7	Ground	

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with cold sparing



5 ELECTRICAL CHARACTERISTICS

The sign convention for current follows JEDEC standards with negative values representing current sourced from the device and positive values representing current sunk into the device.

5.1 ABSOLUTE MAXIMUM RATINGS

Excursions beyond the values listed in Table 3 may cause permanent damage to the device. Proper function of the device cannot be guaranteed if these values are exceeded, and long-term device reliability may be affected. Functionality of the device at these values, or beyond those listed in Recommended Operating Conditions (Table 4) is not guaranteed.

All parameters are specified across the entire operating temperature range unless otherwise specified.

Table 3: Absolute Maximum Ratings

SYMBOL	PARAMETER		VALUE	UNITS
V _{cc}	Supply Voltage		-0.5 to +5.5	V
VI	Input voltage range		-0.5 to +5.5	V
Vo	Output voltage range		-0.5 to V _{CC} + 0.5 ⁽¹⁾	V
I _{IK} (V _I < 0)	Input clamp current		100	mA
Io	Continuous output current (per pin)		100	mA
Icc	Maximum supply current		100	mA
V _{ESD}	ESD Voltage	НВМ	4000	V
VESD	Convoltage	CDM	500	V
Tj	Operating junction temperature range		-55 to +150	°C
T _{STG}	Storage temperature range		-65 to +150	°C

 $^{^{(1)}\,\,}V_{0}$ must remain below absolute maximum rating of V_{CC}

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5.2 RECOMMENDED OPERATING CONDITIONS

All recommended parameters below are specified across the entire operating temperature range unless otherwise specified.

Table 4: Recommended Operating Conditions

SYMBOL	PARAMETER	MIN	MAX	UNITS
V _{CC}	Supply voltage	1.65	5.5	V
Vı	Input voltage range	0	5.5	V
Vo	Output voltage range	0	V_{CC}	V
	V _{CC} = 1.65 to 1.95 V	1.4	-	
V _{IH}	HIGH-level input voltage $V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$	1.9	-	V
VIH	$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$	2.5	-	V
	$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$	3.8	-	
	V_{CC} = 1.65 to 1.95 V	-	0.4	
VIL	LOW-level input voltage $V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$	-	0.6	V
VIL	$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$	-	0.9	
	$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$	-	1.35	
	V_{CC} = 1.65 to 1.95 V	-	-4	- mA
I _{OH}	HIGH-level output current $V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$	-	-8	
'ОН	$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$	-	-16	
	$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$	-	-24	
	V_{CC} = 1.65 to 1.95 V	-	4	
I _{OL}	LOW-level output current $V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$	-	8	mA
IOL	$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$	-	16	ША
	$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$	-	24	
	V _{CC} = 1.65 to 1.95 V	-	1000	
	Input rise or fall time $V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$	-	600	ns
t _r , t _f	(10% - 90%) $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$	-	500	113
	$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$	-	400	

Table 5: Thermal Information

SYMBOL	PARAMETER	MIN	TYP	MAX	UNITS
T _J	Operating junction temperature	-55	-	+125	°C
$R_{\theta JA}$	Junction to ambient thermal resistance	-	100	=	°C/W

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Rad-Hard Dual 3-Input Majority Voter with cold sparing

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5.3 STATIC CHARACTERISTICS

All parameters are specified across the entire operating temperature range unless otherwise specified.

Table 6: DC Electrical Characteristics

SYMBOL	PARAMETER	CONDITIONS	V _{cc}	MIN	TYP	MAX	UNITS
		I _O = 100 μA	1.65 to 5.5 V	=	0.02	0.05	V
		I _O = 1 mA	1.65 to 5.5 V	=	0.05	0.15	V
			1.65 V	-	0.27	8.0	V
		I _O = 4 mA	2.3 V	-	0.3	0.6	V
		10 - 4 IIIA	3.0 V	-	0.2	0.4	V
	LOW-Level		4.5 V	-	0.2	0.4	V
V _{OL}	Output Voltage		2.3 V	-	0.6	1.0	V
	Output vollage	I _O = 8 mA	3.0 V	-	0.4	0.8	V
			4.5 V	-	0.3	0.6	V
		I _O = 16 mA	3.0 V	-	1.0	1.4	V
		1 ₀ - 10 IIIA	4.5 V	-	1.1	1.2	V
		I _O = 24 mA	4.5 V	-	1.1	1.5	V
	HIGH-Level Output Voltage	I _O = -100 μA	1.65 to 5.5 V	V _{CC} - 0.1	V _{CC} - 0.02	-	V
		I _O = -1 mA	1.65 to 5.5 V	V _{CC} - 0.15	V _{CC} - 0.08	-	V
		I _O = -4 mA	1.65 V	1	1.35	-	V
			2.3 V	1.8	2.0	-	V
			3.0 V	2.6	2.8	-	V
			4.5 V	4.2	4.4	-	V
V _{OH}			2.3 V	1.4	1.7	-	V
	Output voltage	$I_0 = -8 \text{ mA}$	3.0 V	2.2	2.5	-	V
			4.5 V	3.9	4.1	-	V
		I _O = -16 mA	3.0 V	1.5	2.0	-	V
		10 - 10 IIIA	4.5 V	3.3	3.8	-	V
		I _O = -24 mA	4.5 V	3.0	3.5	-	V
I _{cc}	Quiescent	$V_I = V_{CC}$ or GND	5.5 V	_	125	205	μA
ıcc	supply current	I _O = 0 mA	J.J V		123	203	μΛ
I _I	Input current	$V_I = V_{CC}$ or GND	1.65 to 5.5 V	-	-	±1	μΑ
I _{OFF}	Powerdown leakage current ⁽¹⁾	V _I = V _{CC} or GND	OFF ⁽²⁾	-	-	5	μΑ

⁽¹⁾ into any input or output port

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⁽²⁾ V_{CC} is at GND potential



5.4 DYNAMIC CHARACTERISTICS

All parameters are specified across the entire operating temperature range unless otherwise specified.

Table 7: AC Electrical Characteristics

SYMBOL	PARAMETER	CONDITIONS	V _{cc}	MIN	TYP	MAX	UNITS
			4.5 to 5.5 V	-	7.6	11	ns
t _{pd} ⁽¹⁾	Propagation Delay	C _L = 50 pF	3.0 to 3.6 V	-	9	13	ns
Lpd	(Input $\mathbf{A_n}$, $\mathbf{B_n}$ or $\mathbf{C_n}$ to Output $\mathbf{Y_n}$)	CL - 30 pi	2.3 to 2.7 V	-	11	15	ns
	Propagation Delay (Input A _n , B _n or C _n		1.65 to 1.95 V	-	17	25	ns
	Propagation Polary		4.5 to 5.5 V	-	11	16	ns
		C 50 pF	3.0 to 3.6 V	-	15	21	ns
t _{err_det}		CL - 30 βι	2.3 to 2.7 V	-	17	24	ns
	το σατρατ Εουτί ί)		1.65 to 1.95 V	-	26	35	ns
			4.5 to 5.5 V	-	7.6	11	ns
	Propagation Delay	C _L = 50 pF	3.0 to 3.6 V	-	9	13	ns
t _{pd_err}	(Input E_{IN} to Output E_{DET})	CL - 50 PF	2.3 to 2.7 V	-	11	15	ns
			1.65 to 1.95 V	-	17	25	ns
C _{in}	Input Capacitance ⁽²⁾	$V_I = V_{CC}$ or GND	1.65 to 5.5 V	-	2	4	pF
C .	Power dissipation	I _O = 0 mA	5.5 V		4.0		pF
C _{pd}	capacitance ⁽²⁾	f = 1 MHz	J.5 V		40	-	h.

 $^{^{(1)}}$ equivalent to t_{PLH} , t_{PHL}

5.5 RADIATION RESILIENCE

For detailed radiation testing reports, please contact Apogee Semiconductor at sales@apogeesemi.com.

Table 8: Radiation Resilience Characteristics

PARAMETER	CONDITIONS	VALUE	UNITS
Total Ionizing Dose (TID)	Please contact Apogee Semiconductor for test report.	30	krad (Si)
Onset SEL LET Threshold	Please contact Apogee Semiconductor for test report.	>80	MeV-cm ² /mg

5.6 CHARACTERISTICS MEASUREMENT INFORMATION

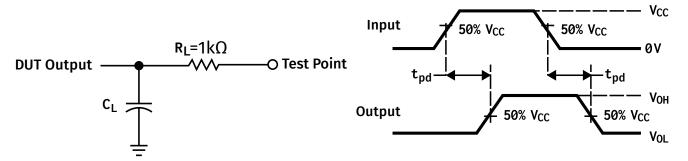


Figure 3: Load Circuit

Figure 4: Propagation Delay Measurement

⁽²⁾ guaranteed by design

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6 DETAILED DESCRIPTION

The AP54RHC301 is a dual three-input majority voter gate that that offers two instances of a triple-input voter gate, with individual error outputs, a dedicated "error detected" output, and an external error signal input. Designed to operate from a wide supply voltage of 1.65 to 5.5 V, it has fully redundant input and output stages providing for superior resiliency to single event effects.

The output and input stages are constructed with transient-activated clamps (Figure 5, 6) that prevent inadvertent biasing of the V_{CC} power rail through parasitic diodes inherent to conventional input, output, and ESD circuits. The IC also incorporates an internal power-on reset (POR) circuit that prevents the output from driving erroneous results during power-on, and guarantees correct operation at power supply voltages as low as 1.65 V. While the supply is ramping, the POR holds the output buffer in tri-state, a feature that prevents unwanted DC current during cold sparing on input and output pins.

The AP54RHC family's I/O protection circuitry allows for cold sparing configurations as it avoids a leakage current penalty on inputs and outputs while in a power-down state. This can result in considerable power savings in systems where multiple-path redundancy is employed. The ESD clamp circuits for this logic family are designed to support Class 2 ESD levels of 4 kV HBM and 500 V CDM.

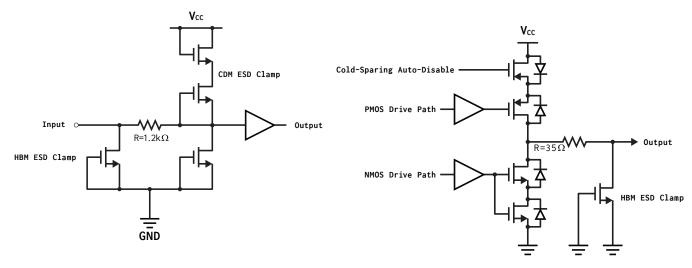


Figure 5: Input Pin Structure

Figure 6: Output Pin Structure

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Rad-Hard Dual 3-Input Majority Voter

with cold sparing



7 APPLICATIONS INFORMATION

The voter function of the AP54RHC301 is intended to allow fault-free glitchless operation in logic systems employing triple redundancy, e.g. where specific logic functions are triplicated and all three identical functions are simultaneously active (Figure 7). This may be simple discrete logic that serves a specific purpose, or complex microcontroller-based logic that is responsible for multiple data-processing and control functions.

The three identical blocks are assumed to perform the same operation, share the same stimuli, and produce the same result at a given single-bit output (e.g., an on/off control line that turns on a valve). These three results are compared by the voter to make sure that they are in agreement.

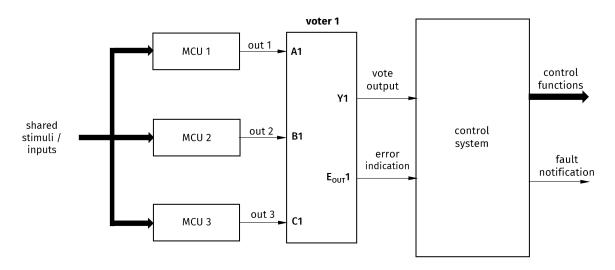


Figure 7: Voter Example

When only two of them are in agreement and the third one is not, the voter's output will produce the result of a majority vote (Y_n) , which assumes that a fault has occurred in the single function whose output did not agree with that of the other two. Alongside the vote result, the voter will also produce an error signal $(E_{OUT}n)$, which may be used to produce a fault notification.

This fault may be either the result of permanent damage in that function, or may be the consequence of a SEE, in which case there is a chance that the block will return to normal functionality and the error indication will be reset. The AP54RHC301 contains two instances of this voting function.

7.1 APPLICATIONS EXAMPLE

As the AP54RHC family is radiation-hardened by design and includes internal TMR, it can be utilized in high-reliablity applications without additional supporting circuitry or devices. Nonetheless, some application requirements call for fully-redundant designs, where an "A" and a "B" device are required, often on separate power rails.

With the cold sparing capability of the AP54RHC family, fully redundant "A" and "B" functions may be placed in parallel (as seen in Figure 8) running off redundant power supplies. The inputs and outputs on each one of these functions are assumed to be based on the AP54RHC family, allowing for direct parallel connection without unwanted leakage current paths during cold sparing. In the event of a failure in power supply A or within function A, the system can simply shut power supply A off and switch on power supply B, without requiring additional input or output switching or configuration changes.

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with cold sparing



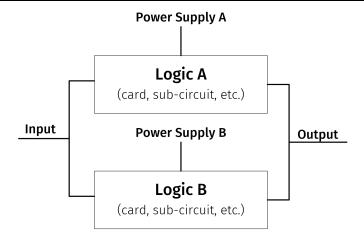


Figure 8: Two-Path Cold-Sparing Configuration

7.2 POWER SUPPLY RECOMMENDATIONS

This device can operate at any voltage within the range specified in Table 4 Recommended Operating Conditions.

At a minimum, a 16 VDC (or higher), X7R-rated 0.1 μF ceramic decoupling capacitor should be placed near (within 1 cm) the V_{CC} pin of the device.

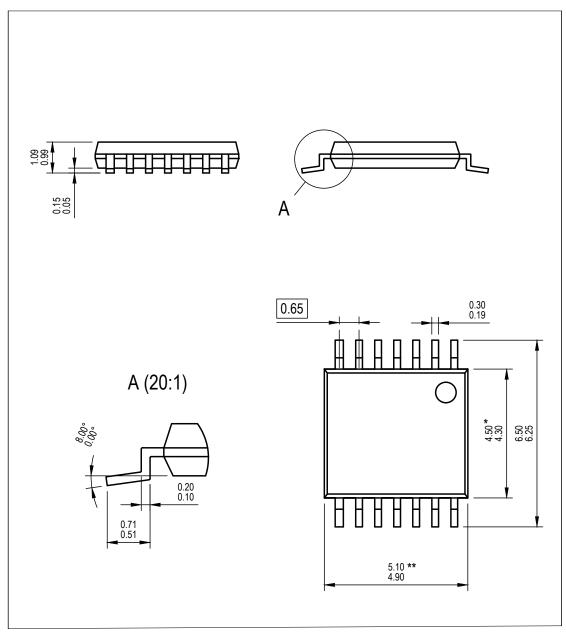
7.3 APPLICATION TIPS

Unused **inputs** must **not** be left floating. They may be connected to either a low (GND) or high (V_{CC}) bias to provide a known state at the input of the device. Resistors may be used to tie off unused inputs. In the event of a design change, such resistors can be removed, thereby allowing use of the inputs without having to cut traces on the PCB.

An unused **output** may be left floating. It is suggested that it be routed to a test point or similar accessible structure in case the gate needs to be utilized as part of a design revision.



8 PACKAGING INFORMATION

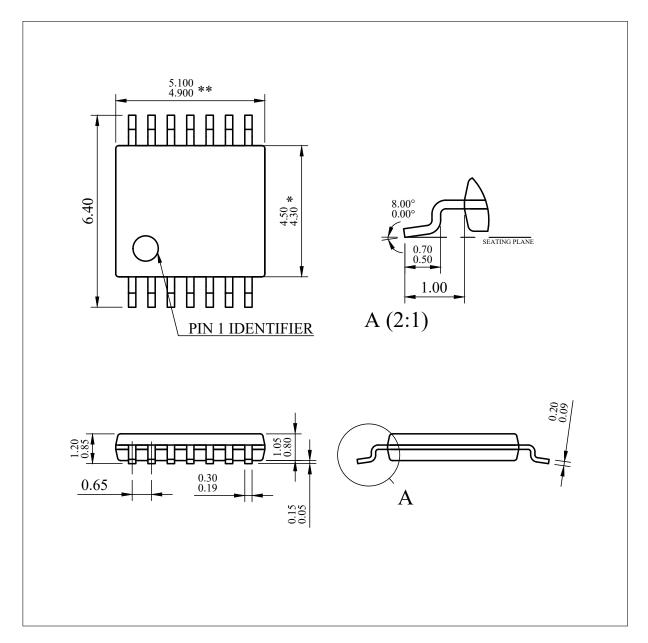


Notes

- 1. All linear dimensions are in millimeters. Dimensioning and tolerancing are as per ISO/TS 128-71:2010 2. The part is compliant with JEDEC MO-153 specifications.
- * Body width does **not** include interlead flash. Interlead flash shall not exceed 0.25 mm each side.
- ** Body length does **not** include mold flash, protrusion, or gate burrs. Mold flash, protrusions, and gate burrs shall not exceed 0.15 mm on each side.

Figure 9: 14-LT - Package Mechanical Drawing (SnPb)





Notes:

- 1. All linear dimensions are in millimeters. Dimensioning and tolerancing are as per ISO/TS 128-71:2010
- 2. The part is compliant with JEDEC MO-153 specifications.
- * Body width does **not** include interlead flash. Interlead flash shall not exceed 0.25 mm each side.
- ** Body length does **not** include mold flash, protrusion, or gate burrs. Mold flash, protrusions, and gate burrs shall not exceed 0.15 mm on each side.

Figure 10: 14-NT - Package Mechanical Drawing (NiPdAu)

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9 ORDERING INFORMATION

Example part numbers for the AP54RHC301 are listed in Table 9. The full list of options for this part can be found in Figure 11. Please contact Apogee Semiconductor sales at sales@apogeesemi.com for further information on sampling, lead time and purchasing on specific part numbers.

Table 9: AP54RHC301 Ordering Information

DEVICE	DESCRIPTION	PACKAGE	LEAD FINISH	PACKAGE DIAGRAM
AP54RHC301ALT-R	Radiation-Hardened Dual 3-Input Majority Voter (30 krad (Si))	TSSOP-14	SnPb	14-LT
AP54RHC301BLT-R	Radiation-Hardened Dual 3-Input Majority Voter (30 krad (Si))	TSSOP-14	SnPb	14-LT
AP54RHC301CLT-R	Radiation-Hardened Dual 3-Input Majority Voter (30 krad (Si))	TSSOP-14	SnPb	14-LT
AP54RHC301ELT-R	Radiation-Hardened Dual 3-Input Majority Voter (for eval only)	TSSOP-14	SnPb	14-LT
AP54RHC301ANT-R	Radiation-Hardened Dual 3-Input Majority Voter (30 krad (Si))	TSSOP-14	NiPdAu	14-NT
AP54RHC301BNT-R	Radiation-Hardened Dual 3-Input Majority Voter (30 krad (Si))	TSSOP-14	NiPdAu	14-NT
AP54RHC301CNT-R	Radiation-Hardened Dual 3-Input Majority Voter (30 krad (Si))	TSSOP-14	NiPdAu	14-NT
AP54RHC301ENT-R	Radiation-Hardened Dual 3-Input Majority Voter (for eval only)	TSSOP-14	NiPdAu	14-NT

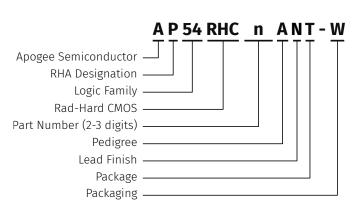


Figure 11: Part Number Decoder

- 1. RHA Designation
 - **P** 30 krad (Si)
 - **F** 300 krad (Si)
- 2. Part Number
 - _ 301 (Dual 3-Input Majority Voter)
- 3. Pedigree
 - **A** -55 to +125 °C (Burn-in)
 - **B** -55 to +125 °C (No burn-in)
 - C 25 °C (No burn-in)
 - **E** 25 °C Functional Test Only (Evaluation)
- 4. Lead Finish
 - L Tin-Lead (SnPb)
 - N Nickel-Palladium-Gold (NiPdAu)
 - **T** Matte Tin (Sn)
- 5. Package
 - **T** 14-pin Thin Shrink Small Outline Package (TSSOP)
- 6. Packaging
 - **W** Waffle Pack or Pillow Stat Box
 - **R** Tape and Reel⁽¹⁾

⁽¹⁾ Contact us for custom reel quantities. Orders less than full reel quantities may be shipped as cut tape.

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10 REVISION HISTORY

Table 10: Revision History

REVISION	DESCRIPTION	DATE
A08	Fixed typographical error in pinout table. Updated figures 3 and 4 in Characteristics Measurement Information. Add NiPdAu option.	2024-07-19
A07	Correct output pin structure diagram.	2021-12-06
A06	Updated ordering information.	2021-07-30
A05	Updated dynamic characteristics values.	2021-07-17
A04	Correct pin mappings in logic diagram.	2021-06-17
A03	Revamped static and dynamic characteristics with new test data.	2021-02-24
A02	Update Static and Dynamic characteristics.	2020-10-23
A01	Initial public release.	2020-02-29
A00	Initial internal release.	2019-07-05

For the latest version of this document, please visit https://www.apogeesemi.com.

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11 LEGAL

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